



N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

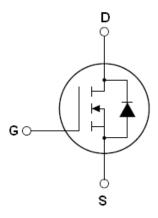
Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V _{DS}	650	V
R _{DS(ON)TYP}	290	mΩ
I_{D}	11.5	A



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking
NCE65T360K	TO-252	NCE65T360K
NCE65T360I	TO-251	NCE65T360I





TO-252

TO-251

Table 1. Absolute Maximum Ratings (T_c=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	650	V
Gate-Source Voltage (V _{DS} =0V) AC (f>1 Hz)	Vgs	±30	V
Continuous Drain Current at T _C =25°C	I _{D (DC)}	11.5	Α
Continuous Drain Current at T _C =100°C	I _{D (DC)}	7	Α
Pulsed drain current (Note 1)	I _{DM (pluse)}	46	Α
Maximum Power Dissipation(T _C =25°C)	P_{D}	101	W
Derate above 25°C		0.97	w/°C
Single pulse avalanche energy (Note2)	Eas	144	mJ
Avalanche current ^(Note 1)	I _{AR}	6	Α
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	0.5	mJ



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Parameter	Symbol	Value	Unit
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55+150	°C

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R_{thJC}	1.24	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R_{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25 ℃ unless otherwise noted)

Parameter	Symbol	Symbol Condition		Тур	Max	Unit
On/off states			ı			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			100	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =250μA	3	3.5	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =7A		290	360	mΩ
Dynamic Characteristics						
Input Capacitance	C _{lss}	\/ -50\/\/ -0\/		870		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V, F=1.0MHz		54		pF
Reverse Transfer Capacitance	C _{rss}	r-1.0ivinz		1.8		pF
Total Gate Charge	Q_g	V _{DS} =480V,I _D =11.5A,		19		nC
Gate-Source Charge	Q_{gs}	V_{DS} =460V, I_{D} =11.5A, V_{GS} =10V		6		nC
Gate-Drain Charge	Q_{gd}	V _{GS} -10V		6.5		nC
Switching times						
Turn-on Delay Time	t _{d(on)}			11		nS
Turn-on Rise Time	t _r	V_{DD} =380 V , I_{D} =5.8 A ,		8		nS
Turn-Off Delay Time	$t_{\text{d(off)}}$	$R_G=3\Omega, V_{GS}=10V$		58	70	nS
Turn-Off Fall Time	t _f			9	14	nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T _C =25°C			11.5	Α
Pulsed Source-drain current(Body Diode)	I _{SDM}	1 _C -25 C			46	Α
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =11.5A,V _{GS} =0V		0.9	1.2	V
Reverse Recovery Time	t _{rr}	T;-25°C -5 0A		220		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I _F =5.8A, di/dt=100A/μs		2.2		uC
Peak Reverse Recovery Current	I _{rrm}	αι/αι-100 <i>Α</i> /μ5		19		Α

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

^{2.} Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

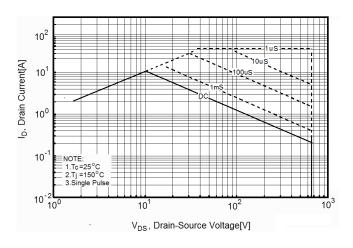


Figure 3. Source-Drain Diode Forward Voltage

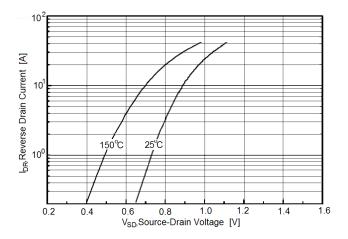


Figure 5. Transfer characteristics

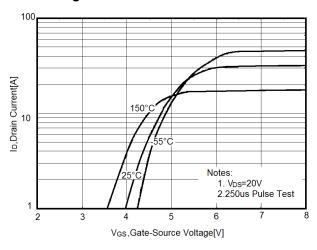


Figure 2. Transient Thermal Impedance

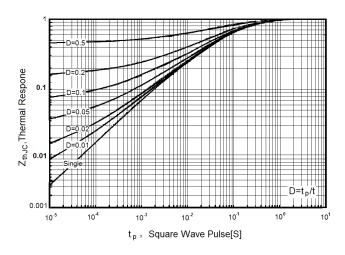


Figure 4. Output characteristics

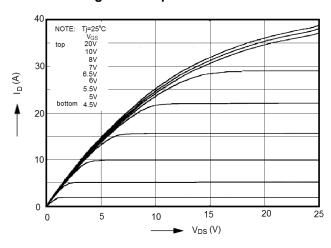
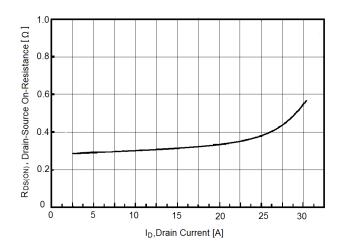


Figure 6. Static drain-source on resistance





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Figure 7. R_{DS(ON)} vs Junction Temperature

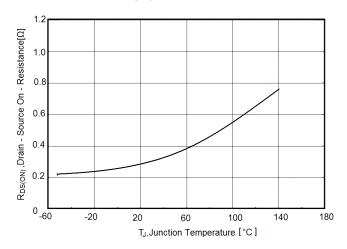


Figure8. BV_{DSS} vs Junction Temperature

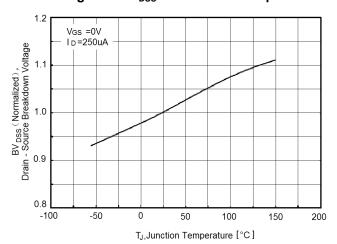


Figure 9. Maximum I_D vs Junction Temperature

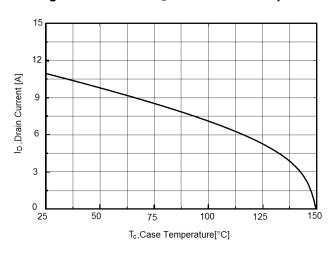


Figure 10. Gate charge waveforms

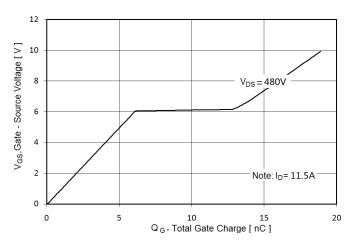
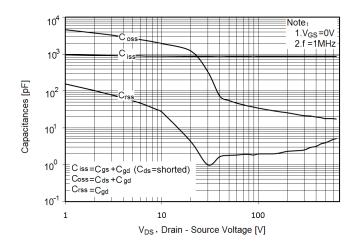


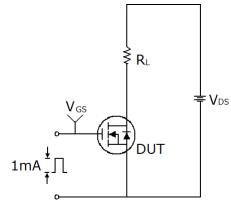
Figure 11. Capacitance

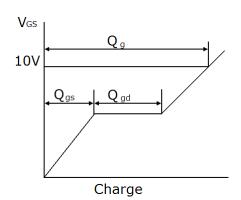




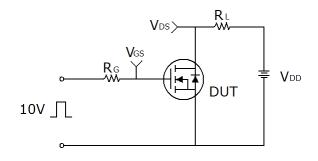
Test circuit

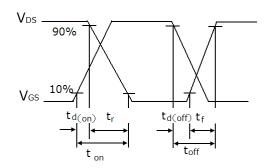
1) Gate charge test circuit & Waveform



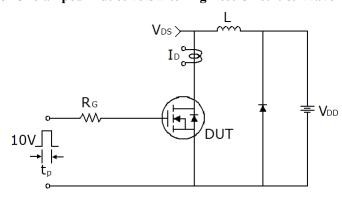


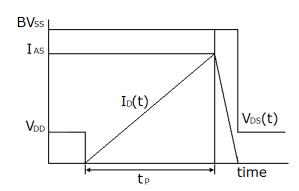
2) Switch Time Test Circuit:





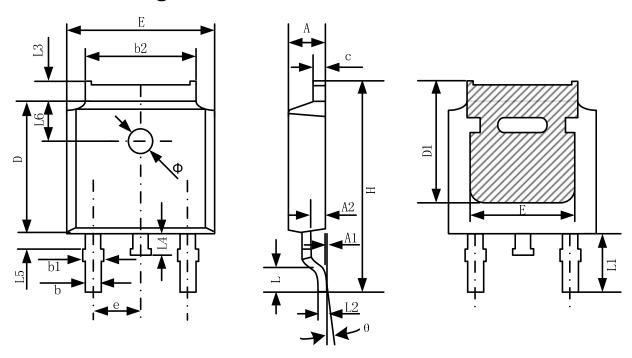
3) Unclamped Inductive Switching Test Circuit & Waveforms







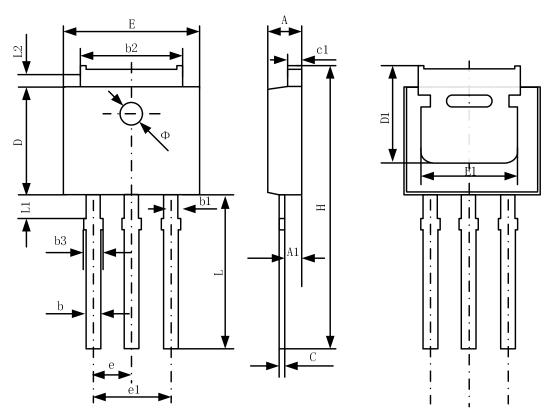
TO-252-2 Package Information



Complete	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.20	2.38	0.087	0.094	
A1	0.00	0.10	0.000	0.004	
A2	0.90	1.10	0.035	0.043	
b	0.72	0.85	0.028	0.033	
b1	0.72	0.90	0.028	0.035	
b2	5.13	5.46	0.202	0.215	
С	0.47	0.60	0.019	0.024	
D	6.00	6.20	0.236	0.244	
D1	5.25		0.207		
E	6.50	6.70	0.256	0.264	
E1	4.70		0.185		
e	2.19	2.39	0.086	0.094	
Н	9.80	10.40	0.386	0.409	
L	1.40	1.70	0.055	0.067	
L1	2.90	REF	0.114 REF		
L2	0.50	8 BSC	0.020 BSC		
L3	0.90	1.25	0.035	0.049	
L4	0.60	1.00	0.024	0.039	
L5	0.15	0.75	0.006	0.030	
L6	1.80 REF		0.071 REF		
Ф	1.20	1.40	0.047	0.055	
θ	0°	8°	0°	8°	



TO-251 Package Information



Cumbal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.20	2.35	0.087	0.093	
A1	0.90	1.10	0.035	0.043	
b	0.56	0.69	0.022	0.027	
b1	0.77	0.90	0.030	0.035	
b2	5.23	5.43	0.206	0.214	
b3		1.05	0.000	0.041	
С	0.46	0.59	0.018	0.023	
c1	0.46	0.59	0.018	0.023	
D	6.00	6.20	0.236	0.244	
D1	5.20		0.205		
E	6.50	6.70	0.256	0.264	
E1	4.60	5.00	0.181		
e	2.24	2.34	0.088	0.092	
e1	4.47	4.67	0.176	0.184	
Н	16.18	16.78	0.637	0.661	
L	9.00	9.60	0.354	0.378	
L1	0.95	1.35	0.037	0.053	
L2	0.90	1.25	0.035	0.049	

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